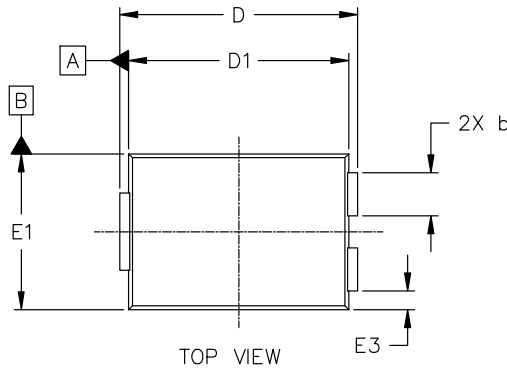


**TO-277-3 5.91x4.44x1.10, 2.10P**  
**CASE 340BQ**  
**ISSUE A**

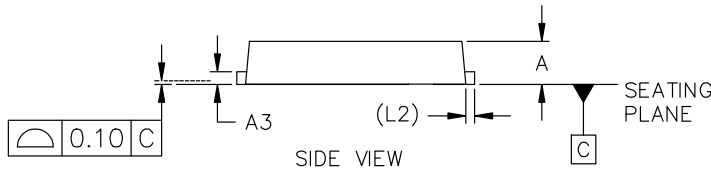
DATE 16 APR 2026

NOTES:

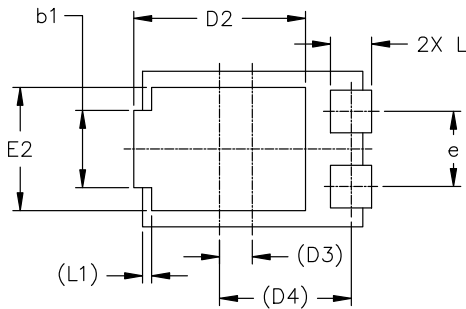
1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M, 2018.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD FLASH, MOLD FLASH SHALL NOT EXCEED 0.13 mm PER SIDE.



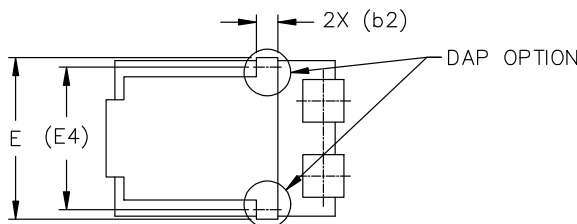
TOP VIEW



SIDE VIEW

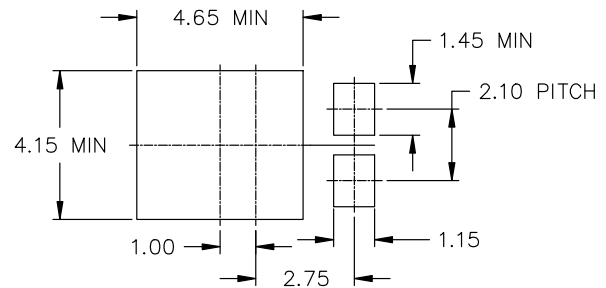


BOTTOM VIEW



BOTTOM VIEW - DAP OPTION

MILLIMETERS			
DIM	MIN	NOM	MAX
A	1.00	1.10	1.20
A3	0.23	0.32	0.40
b	1.10	1.25	1.40
b1	1.95	2.10	2.25
b2	0.60 REF		
D	6.35	6.50	6.65
D1	5.67	5.91	6.15
D2	4.23	4.57	4.90
D3	0.913 REF		
D4	3.680 REF		
E	---	---	4.75
E1	4.25	4.44	4.63
E2	3.25	3.48	3.70
E3	0.43	0.53	0.63
E4	3.680 REF		
e	2.00	2.10	2.20
L	0.90	1.08	1.25
L1	0.25 REF		
L2	0.35 REF		



RECOMMENDED MOUNTING FOOTPRINT

\*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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<b>DESCRIPTION:</b>	<b>TO-277-3 5.91x4.44x1.10, 2.10P</b>	<b>PAGE 1 OF 1</b>

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